

## SKiiP 11 NEC 06 - SKiiP 11 NEC 06 I

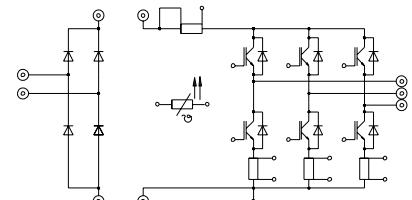
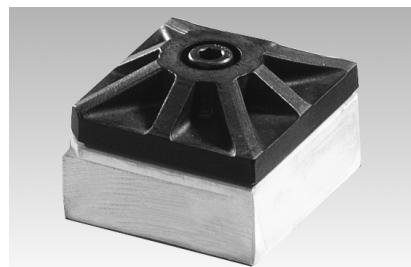
<b>Absolute Maximum Ratings</b>		<b>Values</b>	<b>Units</b>
<b>Symbol</b>	<b>Conditions <sup>1)</sup></b>		
Inverter			
$V_{CES}$		600	V
$V_{GES}$		$\pm 20$	V
$I_C$	$T_{heatsink} = 25 / 80^\circ\text{C}$	17 / 12	A
$I_{CM}$	$t_p < 1 \text{ ms}; T_{heatsink} = 25 / 80^\circ\text{C}$	34 / 24	A
$I_F = -I_C$	$T_{heatsink} = 25 / 80^\circ\text{C}$	20 / 15	A
$I_{FM} = -I_{CM}$	$t_p < 1 \text{ ms}; T_{heatsink} = 25 / 80^\circ\text{C}$	40 / 30	A
Bridge Rectifier			
$V_{RRM}$		800	V
$I_D$	$T_{heatsink} = 80^\circ\text{C}$	12	A
$I_{FSM}$	$t_p = 10 \text{ ms}; \sin. 180^\circ, T_j = 25^\circ\text{C}$	370	A
$I^2t$	$t_p = 10 \text{ ms}; \sin. 180^\circ, T_j = 25^\circ\text{C}$	680	$\text{A}^2\text{s}$
$T_j$		-40 ... +150	$^\circ\text{C}$
$T_{stg}$		-40 ... +125	$^\circ\text{C}$
$V_{isol}$	AC, 1 min.	2500	V

<b>Characteristics</b>		<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Units</b>
<b>Symbol</b>	<b>Conditions <sup>1)</sup></b>				
IGBT - Inverter					
$V_{CEsat}$	$I_C = 10 \text{ A}, T_j = 25 (125)^\circ\text{C}$	-	2,1(2,2)	2,7(2,8)	V
$t_{d(on)}$	$\left. \begin{array}{l} V_{CC} = 300 \text{ V}; V_{GE} = \pm 15 \text{ V} \\ I_C = 10 \text{ A}; T_j = 125^\circ\text{C} \end{array} \right\}$	-	40	80	ns
$t_r$	$I_C = 10 \text{ A}; T_j = 125^\circ\text{C}$	-	60	120	ns
$t_{d(off)}$	$R_{gon} = R_{goff} = 100 \Omega$	-	250	400	ns
$t_f$	inductive load	-	500	750	ns
$E_{on} + E_{off}$		-	1,2	-	mJ
$C_{ies}$	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}, 1 \text{ MHz}$	-	0,57	-	nF
$R_{thjh}$	per IGBT	-	-	2,3	K/W
Diode <sup>2)</sup>	- Inverter				
$V_F = V_{EC}$	$I_F = 10 \text{ A}, T_j = 25 (125)^\circ\text{C}$	-	1,45(1,4)	1,7(1,7)	V
$V_{TO}$	$T_j = 125^\circ\text{C}$	-	0,85	0,9	V
$r_T$	$T_j = 125^\circ\text{C}$	-	55	80	$\text{m}\Omega$
$I_{RRM}$	$I_F = 10 \text{ A}, V_R = -300 \text{ V}$	-	13	-	A
$Q_{rr}$	$\left. \begin{array}{l} \text{di}_F/\text{dt} = -200 \text{ A}/\mu\text{s} \\ V_{GE} = 0 \text{ V}, T_j = 125^\circ\text{C} \end{array} \right\}$	-	1,5	-	$\mu\text{C}$
$E_{off}$		-	0,45	-	mJ
$R_{thjh}$	per diode	-	-	2,7	K/W
Diode - Rectifier					
$V_F$	$I_F = 25 \text{ A}, T_j = 25^\circ\text{C}$	-	1,2	-	V
$R_{thjh}$	per diode	-	-	2,6	K/W
Temperature Sensor					
$R_{TS}$	$T = 25 / 100^\circ\text{C}$	1000 / 1670			$\Omega$
Shunts (SKiiP 11 NEC 06 I)					
$R_{cs(dc)}$	5 % <sup>4)</sup>	47			$\text{m}\Omega$
$R_{cs(ac)}$	1 %	22			$\text{m}\Omega$
Mechanical Data					
$M_1$	case to heatsink, SI Units	2	-	2,5	Nm
Case	mechanical outline see page B 16 - 5		M1		

**MiniSKiiP 1**  
**SEMIKRON integrated**  
**intelligent Power**

**SKiiP 11 NEC 06**  
**SKiiP 11 NEC 06 I <sup>3)</sup>**  
**1-phase bridge rectifier +**  
**3-phase bridge inverter**

Case M1



UL recognized file no. E63532

- common characteristics see page B16-3
- specification of shunts and temperature sensor see part A

#### Options

- also available with faster IGBTs (type ... 063), data sheet on request

<sup>1)</sup>  $T_{heatsink} = 25^\circ\text{C}$ , unless otherwise specified

<sup>2)</sup> CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

<sup>3)</sup> With integrated DC and/or AC shunts

<sup>4)</sup> accuracy of pure shunt, please note that for DC shunt no separate sensing contact is used.

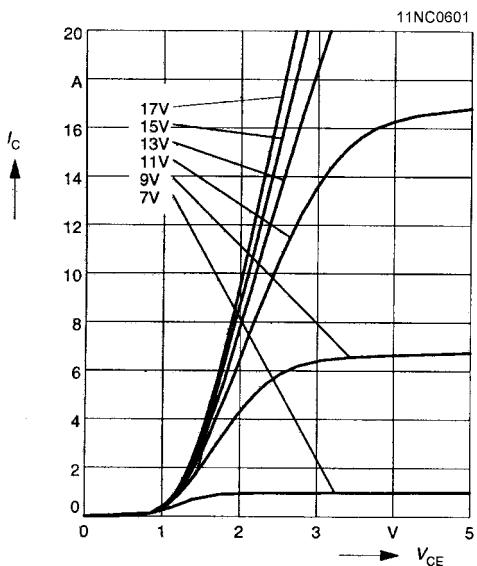


Fig. 1 Typ. output characteristic,  $t_p = 80 \mu\text{s}$ ;  $25^\circ\text{C}$

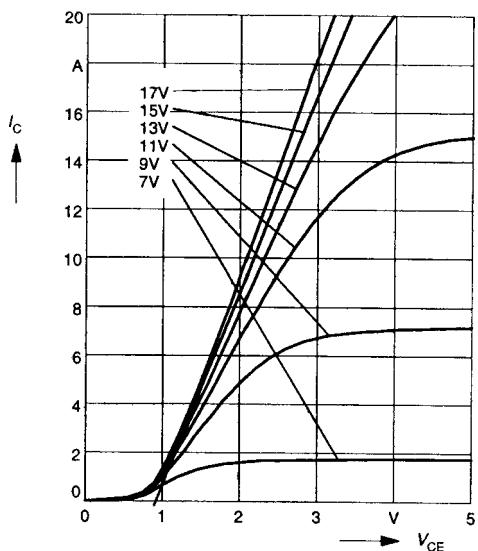


Fig. 2 Typ. output characteristic,  $t_p = 80 \mu\text{s}$ ;  $125^\circ\text{C}$

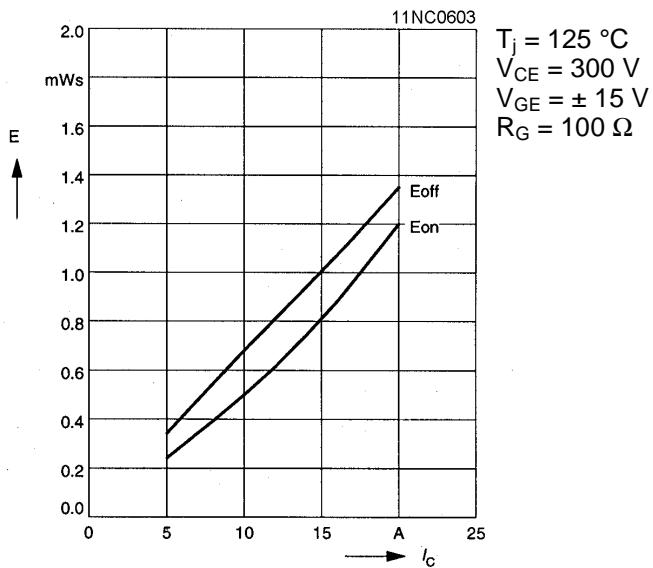


Fig. 3 Turn-on /-off energy = f (I\_C)

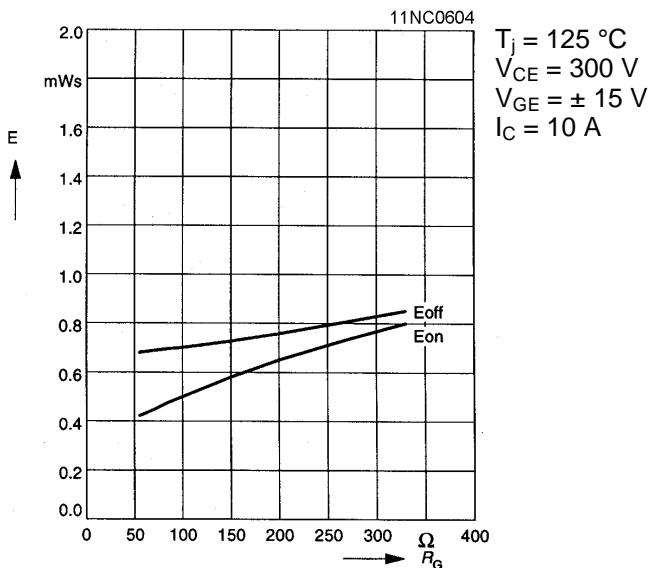


Fig. 4 Turn-on /-off energy = f (R\_G)

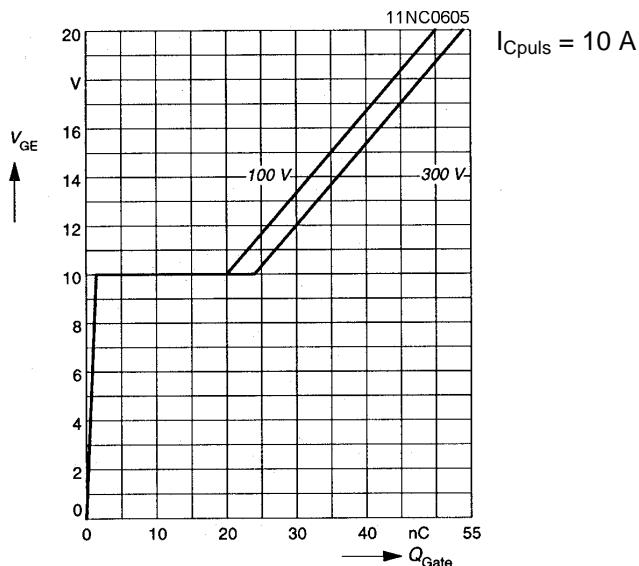


Fig. 5 Typ. gate charge characteristic

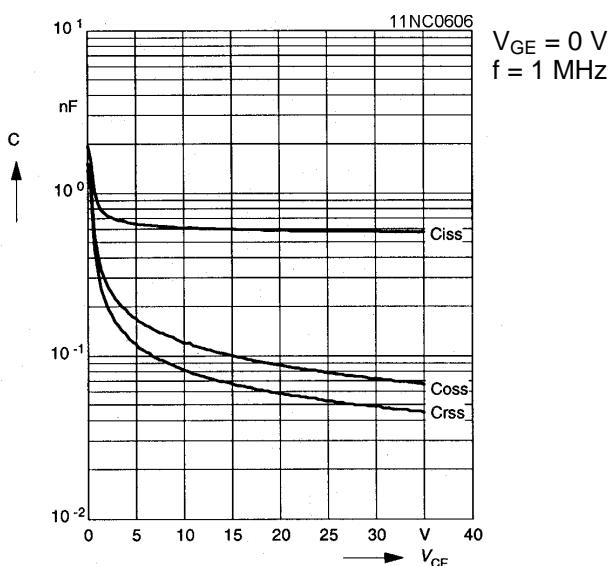


Fig. 6 Typ. capacitances vs.  $V_{CE}$

## 2. Common characteristics of MiniSKiiP

### MiniSKiiP 600 V

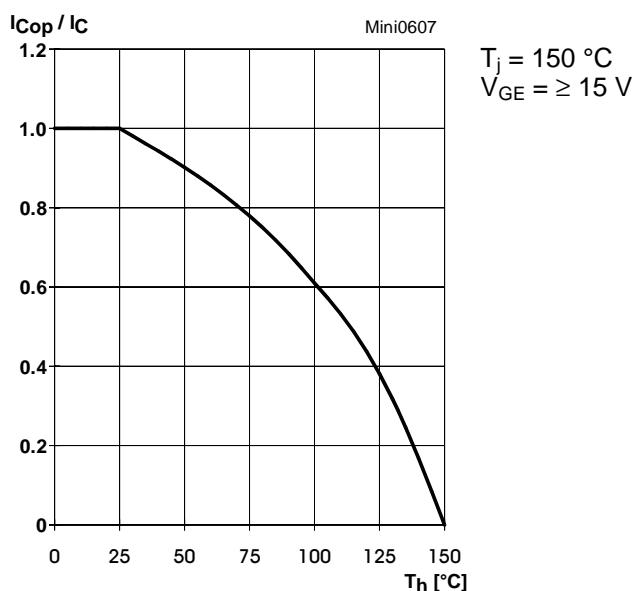


Fig. 7 Rated current of the IGBT  $I_{C_{op}} / I_C = f(T_j)$

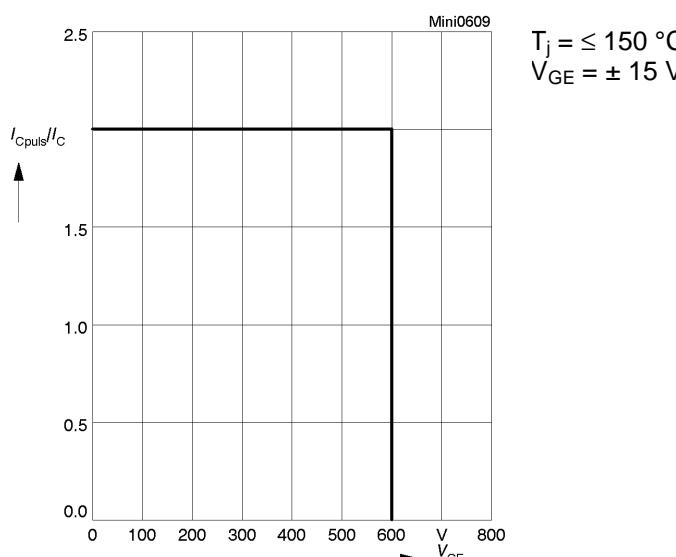


Fig. 9 Turn-off safe operating area (RBSOA) of the IGBT

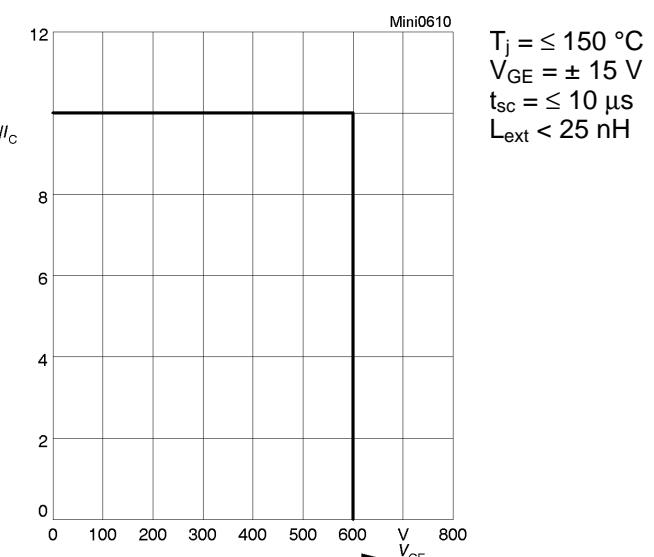


Fig. 10 Safe operating area at short circuit of the IGBT

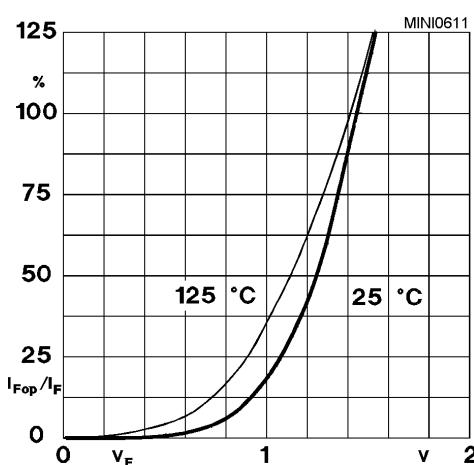


Fig. 11 Typ. freewheeling diode forward characteristic

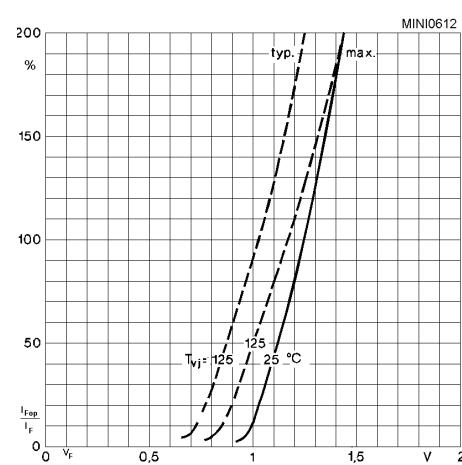


Fig. 12 Forward characteristic of the input bridge diode

MiniSKiiP 1

SKiiP 10 NEC 06 ... Circuit  
SKiiP 11 NEC 06 ... Case M1  
Layout and connections for the  
customer's printed circuit board  
Note: The shunts are available  
only by option I

